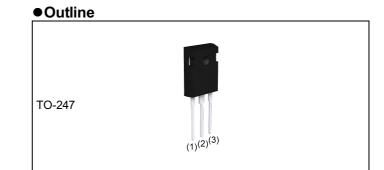
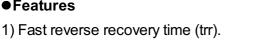


| V <sub>DSS</sub>           | 600V   |
|----------------------------|--------|
| R <sub>DS(on)</sub> (Max.) | 0.081Ω |
| I <sub>D</sub>             | ±47A   |
| P <sub>D</sub>             | 440W   |



### Inner circuit



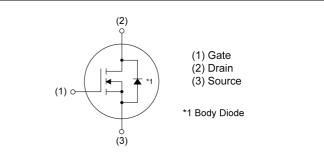
2) Low on-resistance.

Features

- 3) Fast switching speed.
- 4) Gate-source voltage ( $V_{GSS}$ ) guaranteed to be ±30V.
- 5) Drive circuits can be simple.
- 6) Pb-free plating ; RoHS compliant

## Application

Switching Power Supply



## Packaging specifications

|      | Packing                   | Tube      |
|------|---------------------------|-----------|
|      | Reel size (mm)            | -         |
| Tuna | Tape width (mm)           | -         |
| Туре | Basic ordering unit (pcs) | 450       |
|      | Taping code               | C9        |
|      | Marking                   | R6047MNZ1 |
|      |                           |           |

## • Absolute maximum ratings (T<sub>a</sub> = 25°C ,unless otherwise specified)

| Symbol             | Value  | Unit   |
|--------------------|--|--|
| V <sub>DSS</sub>   | 600  | V  |
| I <sub>D</sub> *1  | ±47  | А  |
| I <sub>DP</sub> *2 | ±141   | А  |
| V <sub>GSS</sub>   | ±30  | V  |
| I <sub>AS</sub>    | 7.0  | А  |
| E <sub>AS</sub>    | 13.35  | mJ   |
| P <sub>D</sub>     | 440  | W  |
| Tj                 | 150  | °C   |
| T <sub>stg</sub>   | -55 to +150  | °C   |
|                    | $V_{DSS}$ $I_{D}^{*1}$ $I_{DP}^{*2}$ $V_{GSS}$ $I_{AS}$ $E_{AS}$ $P_{D}$ $T_{j}$ | $\begin{array}{c c c c c c c c c c c c c c c c c c c $ |

### •Thermal resistance

| Deremeter                                    | Cumph of          | Values |      |      | Lincit |
|--|-------------------|--------|------|------|--------|
| Parameter                                    | Symbol            | Min.   | Тур. | Max. | Unit   |
| Thermal resistance, junction - case          | R <sub>thJC</sub> | -      | -    | 0.28 | °C/W   |
| Thermal resistance, junction - ambient       | R <sub>thJA</sub> | -      | -    | 30   | °C/W   |
| Soldering temperature, wavesoldering for 10s | T <sub>sold</sub> | -      | -    | 265  | °C     |

## •Electrical characteristics (T<sub>a</sub> = 25°C)

| Deremeter                                      | rameter Symbol Conditions              |   | Values |       |       | Unit |
|--|--|---|--------|-------|-------|------|
| Parameter                                      |  |   | Min.   | Тур.  | Max.  |      |
| Drain - Source breakdown<br>voltage            | $V_{(BR)DSS}$ $V_{GS} = 0V, I_D = 1mA$ |   | 600    | -     | -     | V    |
|  |  | V <sub>DS</sub> = 600V, V <sub>GS</sub> = 0V  |        |       |       |      |
| Zero gate voltage<br>drain current             | I <sub>DSS</sub>                       | $T_j = 25^{\circ}C$                           | -      | -     | 100   | μA   |
|  |  | T <sub>j</sub> = 125°C                        | -      | -     | -     |      |
| Gate - Source leakage current                  | I <sub>GSS</sub>                       | $V_{GS}$ = ±30V, $V_{DS}$ = 0V                | -      | -     | ±100  | nA   |
| Gate threshold voltage                         | $V_{GS(th)}$                           | V <sub>DS</sub> = 10V, I <sub>D</sub> = 1.2mA | 3.0    | -     | 5.0   | V    |
|  |  | V <sub>GS</sub> = 10V, I <sub>D</sub> = 23.5A |        |       |       |      |
| Static drain - source<br>on - state resistance | $R_{DS(on)}^{*3}$                      | $T_j = 25^{\circ}C$                           | -      | 0.060 | 0.081 | Ω    |
|  |  | $T_j = 125^{\circ}C$                          | -      | -     | -     |      |
| Gate resistance                                | $R_G$                                  | f = 1MHz, open drain                          | -      | 0.8   | -     | Ω    |



## •Electrical characteristics (T<sub>a</sub> = 25°C)

| Devenuetor                     | C: make al  | Conditions                            |      | Linit |      |      |  |
|--------------------------------|---|---------------------------------------|------|-------|------|------|--|
| Parameter                      | Symbol  | Conditions                            | Min. | Тур.  | Max. | Unit |  |
| Forward Transfer<br>Admittance | $ Y_{fs} ^{*3}$ V <sub>DS</sub> = 10V, I <sub>D</sub> = 23.5A |                                       | 15   | -     | -    | S    |  |
| Input capacitance              | C <sub>iss</sub>  | V <sub>GS</sub> = 0V                  | -    | 3800  | -    |      |  |
| Output capacitance             | C <sub>oss</sub>  | V <sub>DS</sub> = 25V                 | -    | 3800  | -    | pF   |  |
| Reverse transfer capacitance   | C <sub>rss</sub>  | f = 1MHz                              | -    | 35    | -    |      |  |
| Turn - on delay time           | t <sub>d(on)</sub> *3   | $V_{DD} \simeq 300$ V, $V_{GS}$ = 10V | -    | 50    | -    |      |  |
| Rise time                      | t <sub>r</sub> *3   | I <sub>D</sub> = 23.5A                | -    | 150   | -    | 20   |  |
| Turn - off delay time          | t <sub>d(off)</sub> *3  | R <sub>L</sub> ≃ 12.7Ω                | -    | 95    | -    | ns   |  |
| Fall time                      | t <sub>f</sub> *3   | R <sub>G</sub> = 10Ω                  | -    | 27    | -    |      |  |

## • Gate charge characteristics (T<sub>a</sub> = 25°C)

| Deremeter            | Cump of                | Conditions                         |      | L locit |      |      |
|----------------------|------------------------|------------------------------------|------|---------|------|------|
| Parameter            | Symbol                 | Conditions                         | Min. | Тур.    | Max. | Unit |
| Total gate charge    | Q <sub>g</sub> *3      | V <sub>DD</sub> ≃ 300V             | -    | 70      | -    |      |
| Gate - Source charge | Q <sub>gs</sub> *3     | I <sub>D</sub> = 47A               | -    | 32      | -    | nC   |
| Gate - Drain charge  | Q <sub>gd</sub> *3     | V <sub>GS</sub> = 10V              | -    | 22      | -    |      |
| Gate plateau voltage | V <sub>(plateau)</sub> | $V_{DD} \simeq 300V$ , $I_D = 47A$ | -    | 6.9     | -    | V    |

\*1 Limited only by maximum temperature allowed.

\*2 Pw  $\leq$  10µs, Duty cycle  $\leq$  1%

\*3 Pulsed

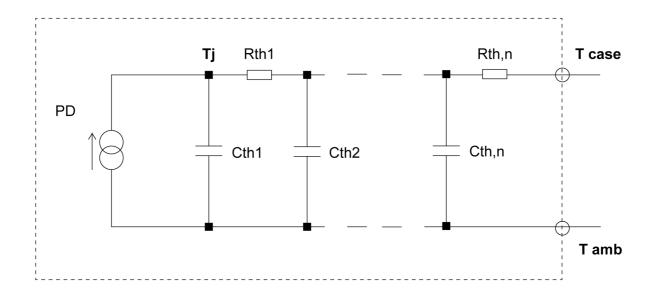


## •Body diode electrical characteristics (Source-Drain) (T<sub>a</sub> = 25°C)

| Parameter                     | Sumbol              | Conditions                                 | Values |      |      | Unit |  |
|-------------------------------|---------------------|--|--------|------|------|------|--|
| Parameter                     | Symbol              | Conditions                                 | Min.   | Тур. | Max. | Unit |  |
| Continuous forward current    | ۱ <sub>S</sub> *1   | T - 25°0                                   | -      | -    | 47   | А    |  |
| Pulse forward current         | ا <sub>SP</sub> *2  | T <sub>C</sub> = 25°C                      | -      | -    | 141  | А    |  |
| Forward voltage               | $V_{SD}^{*3}$       | V <sub>GS</sub> = 0V, I <sub>S</sub> = 47A | -      | -    | 1.5  | V    |  |
| Reverse recovery time         | t <sub>rr</sub> *3  |  | 65     | 105  | 145  | ns   |  |
| Reverse recovery charge       | Q <sub>rr</sub> *3  | I <sub>S</sub> = 47A<br>di/dt = 100A/µs    | 280    | 450  | 620  | nC   |  |
| Peak reverse recovery current | ۱ <sub>rrm</sub> *3 |  | -      | -    | -    | А    |  |

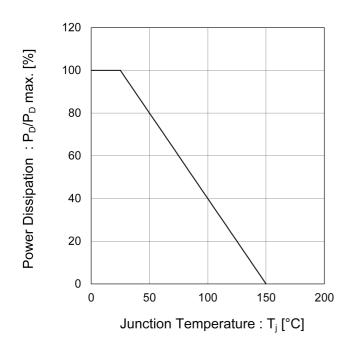
## • Typical transient thermal characteristics

| Symbol           | Value  | Unit | Sym             | bol | Value   | Unit |
|------------------|--------|------|-----------------|-----|---------|------|
| R <sub>th1</sub> | 0.1263 |      | C <sub>th</sub> | 1   | 0.02321 |      |
| R <sub>th2</sub> | 0.762  | K/W  | C <sub>th</sub> | 12  | 0.4502  | Ws/K |
| R <sub>th3</sub> | 35.94  |      | C <sub>th</sub> | 13  | 2.240   |      |





## • Electrical characteristic curves



## Fig.1 Power Dissipation Derating Curve

Fig.2 Maximum Safe Operating Area

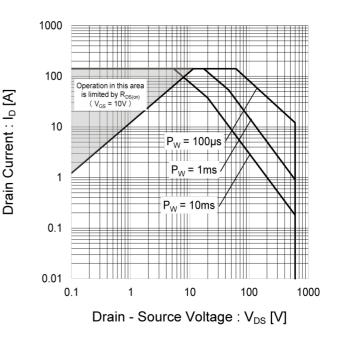
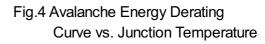
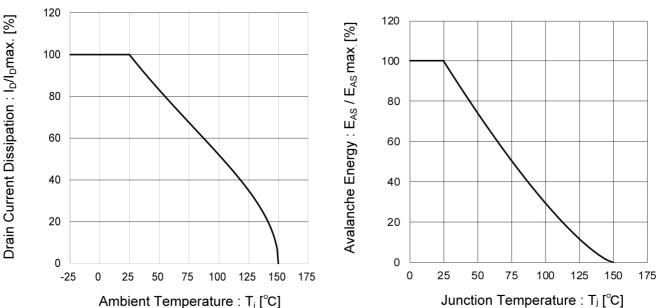


Fig.3 Drain Current Derating Curve vs. Ambient Temperature





Junction Temperature : T<sub>j</sub> [°C]



10

8

6

4

2

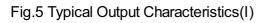
0

0

0.2

T<sub>a</sub> = 25°C

Pulsed



6.0V

V<sub>GS</sub> = 5.5V

5.0V

1

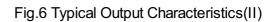
0.8

10V

8.0V

7.0V

6.5V



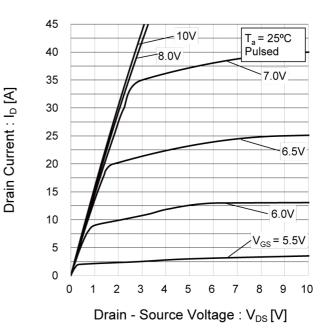


Fig.7 Normalized Breakdown Voltage vs. Junction Temperature

Drain - Source Voltage : V<sub>DS</sub> [V]

0.4

0.6

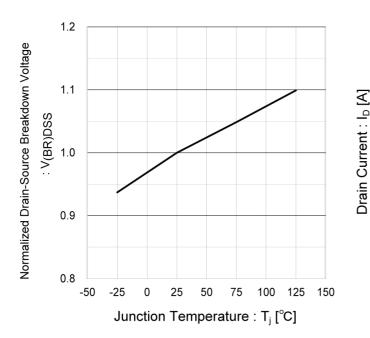
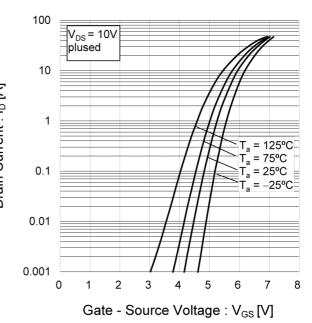
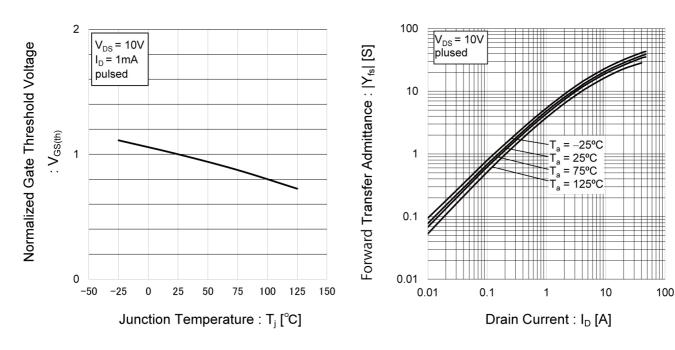


Fig.8 Typical Transfer Characteristics

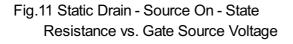




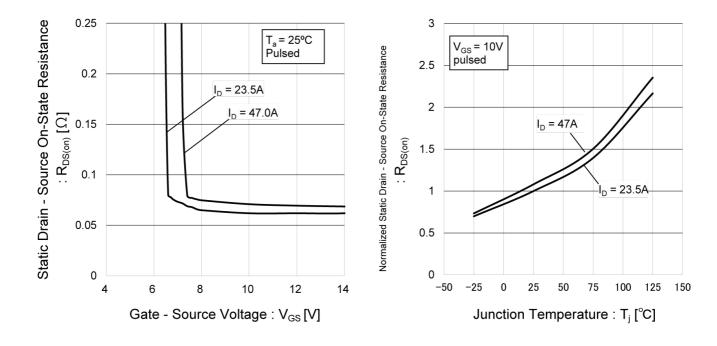
## •Electrical characteristic curves



## Fig.9 Normalized Gate Threshold Voltage. vs Junction Temperature



## Fig.12 Normalized Static Drain - Source On - State Resistance vs. Junction Temperature



## Fig.10 Forward Transfer Admittance vs. Drain Current



## • Electrical characteristic curves

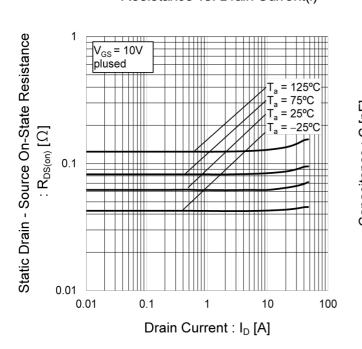


Fig.13 Static Drain - Source On - State Resistance vs. Drain Current(I) Fig.14 Typical Capacitance vs. Drain - Source Voltage

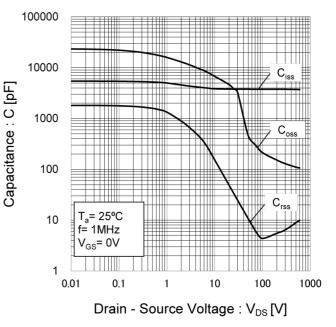


Fig.15 Switching Characteristics

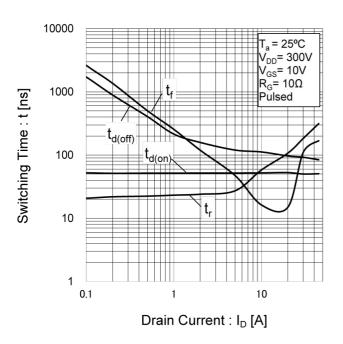


Fig.16 Dynamic Input Characteristics

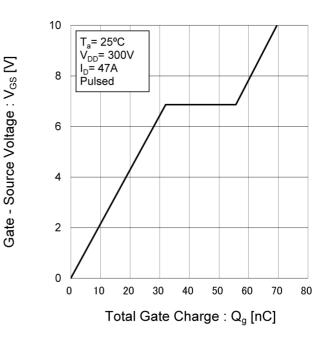
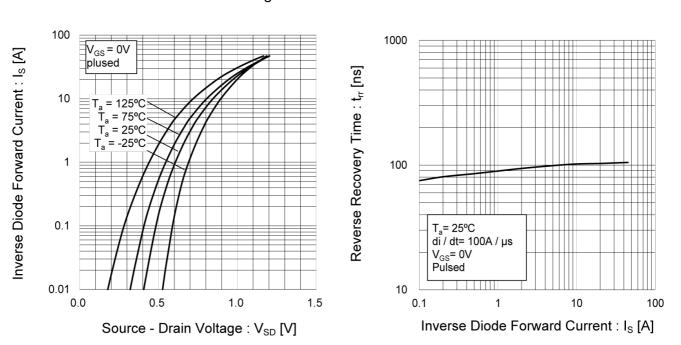




Fig.18 Reverse Recovery Time vs.

**Inverse Diode Forward Current** 

## • Electrical characteristic curves



# Fig.17 Inverse Diode Forward Current vs. Source - Drain Voltage

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### Measurement circuits

#### Fig.1-1 Switching Time Measurement Circuit

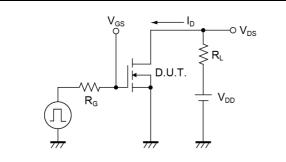


Fig.2-1 Gate Charge Measurement Circuit

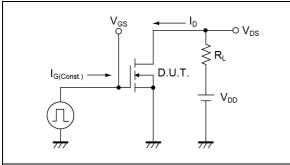


Fig.3-1 Avalanche Measurement Circuit

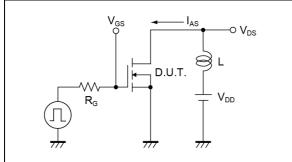


Fig.4-1 dv/dt Measurement Circuit

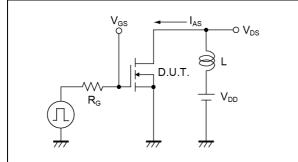
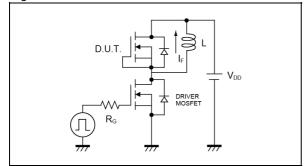
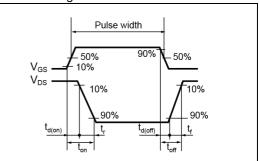


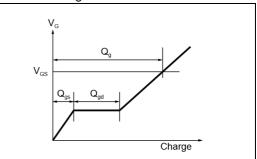
Fig.5-1 di/dt Measurement Circuit



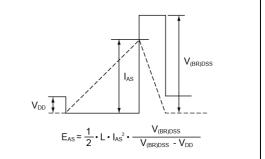
#### Fig.1-2 Switching Waveforms



#### Fig.2-2 Gate Charge Waveform



#### Fig.3-2 Avalanche Waveform



#### Fig.4-2 dv/dt Waveform

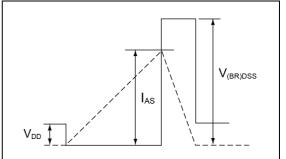
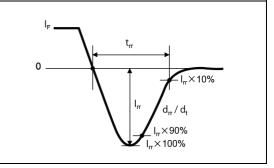
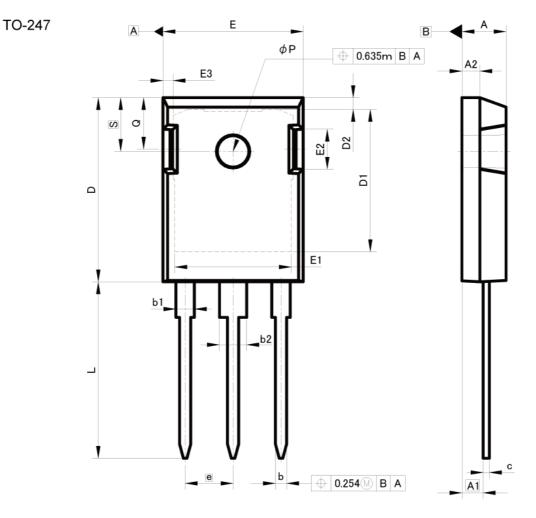


Fig.5-2 di/dt Waveform





## Dimensions



| DIM | MILIM | MILIMETERS |       | HES   |  |
|-----|-------|------------|-------|-------|--|
| DIW | MIN   | MAX        | MIN   | MAX   |  |
| А   | 4.83  | 5.21       | 0.19  | 0.205 |  |
| A1  | 2.29  | 2.54       | 0.09  | 0.1   |  |
| A2  | 1.91  | 2.16       | 0.075 | 0.085 |  |
| b   | 1.14  | 1.40       | 0.045 | 0.055 |  |
| b1  | 1.91  | 2.20       | 0.075 | 0.087 |  |
| b2  | 2.92  | 3.20       | 0.115 | 0.126 |  |
| с   | 0.61  | 0.80       | 0.024 | 0.031 |  |
| D   | 20.80 | 21.34      | 0.819 | 0.84  |  |
| D1  | 17.43 | 17.83      | 0.686 | 0.702 |  |
| E   | 15.75 | 16.13      | 0.62  | 0.635 |  |
| е   | 5.4   | 45         | 0.    | 22    |  |
| Ν   | :     | 3          |       | 3     |  |
| L   | 19.81 | 20.57      | 0.78  | 0.81  |  |
| L1  | 3.81  | 4.07       | 0.15  | 0.16  |  |
| ΦP  | 3.55  | 3.65       | 0.14  | 0.144 |  |
| Q   | 5.59  | 6.20       | 0.22  | 0.244 |  |
| S   | 6.    | 15         | 0.    | 24    |  |

Dimension in mm/inches



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| (Note1) Medical Equipment Classification of the Specific Applications |
|---|
|---|

| JÁPAN  | USA     | EU         | CHINA   |
|--------|---------|------------|---------|
| CLASSⅢ | CLASSⅢ  | CLASS II b | CLASSII |
| CLASSⅣ | CLASSII | CLASSⅢ     | CLASSI  |

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  - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
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  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

#### Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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## R6047MNZ1 - Web Page

| Part Number                 | R6047MNZ1 |
|-----------------------------|-----------|
| Package                     | TO-247    |
| Unit Quantity               | 450       |
| Minimum Package Quantity    | 30        |
| Packing Type                | Tube      |
| Constitution Materials List | inquiry   |
| RoHS                        | Yes       |